

1/24/2011

PRODUCT RELIABILITY REPORT FOR

78M6613

Maxim Integrated Products

4401 South Beltwood Parkway Dallas, TX 75244-3292

Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

78M6613

In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts AfT = Acceleration factor due to Temperature tu = Time at use temperature (e.g. 55°C) ts = Time at stress temperature (e.g. 125°C) k = Boltzmann's Constant (8.617 x 10-5 eV/°K) Tu = Temperature at Use (°K) Ts = Temperature at Stress (°K) Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

AfV = exp(B*(Vs - Vu)) AfV = Acceleration factor due to Voltage Vs = Stress Voltage (e.g. 7.0 volts) Vu = Maximum Operating Voltage (e.g. 5.5 volts) B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

Fr = X/(ts * AfV * AfT * N * 2)X = Chi-Sq statistical upper limit N = Life test sample size Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILU	RE RATE:	MTTF (YRS):	26556	F	ITS:	4.3		
		DEVICE HC	URS: 213	155768	FA	ILS:	0		
Only data from C	Only data from Operating Life or similar stresses are used for this calculation.								
The parameters	used to calculat	e this failure	ate are as fo	llows:					
Cf: 60	% Ea:	0.7 E	: 0	Tu:	25	°C	Vu: 3.6	Volts	

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Informati	on:										
Process:	TSMC 0.25um, Mixed signal, Embedded flash, General Purpose, Double poly Quad metal, 2.5V/3.3V							uble			
Passivation: SiO/SiN = 1000nm/											
Die Size:											
Number of Transistors:			379919								
Interconnect: Gate Oxide Thickness:		Alumin 70 Å	Aluminum / 0.5% Copper 70 Å								
ESD HBM											
DESCRIPTION	DATE	ATE CODE/PRODUCT/LOT		CONDITION	READPOIN		QTY	FAILS	FA#		
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A114 HBM 500 VOLTS	1	PUL'S	3	0			
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A114 HBM 1000 VOLTS	1	PUL'S	3	0			
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A114 HBM 2000 VOLTS	1	PUL'S	3	0			
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A114 HBM 4000 VOLTS	1	PUL'S	3	0			
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A114 HBM 5000 VOLTS	1	PUL'S	3	0			
					Total:			0			
ESD MM											
DESCRIPTION	DATE	DATE CODE/PRODUCT/LOT		CONDITION	READPOIN		QTY	FAILS	FA#		
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A115 MM 100 VOLTS	1	PUL'S	3	0			
ESD SENSITIVITY	0222	78M6613	26728	JESD22-A115 MM 200 VOLTS	1	PUL'S	3	0			
					Total:			0			
LATCH-UP											
DESCRIPTION Rev B, 1/3/08	DATE	CODE/PRODU	JCT/LOT	CONDITION	RE	Adpoin	QTY	FAILS	FA#		

LATCH-UP I	0222	78M6613	26728	JESD78 200mA	A, I-TEST 25C			6	0	
LATCH-UP V	0222	78M6613	26728	JESD78 TEST 25	A, V-SUPPLY 6C			6	0	
						Total:		0		
OPERATING LIFE										
DESCRIPTION	DATE	CODE/PRODUCT	/LOT	CONDIT	ION	REAL	OPOIN	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0222	78M6613	26728	125C, 3.	6 VOLTS	1000	HRS	76	0	
HIGH TEMP OP LIFE	1026	71M6103	26803	125C, 3.	3 VOLTS	500	HRS	200	0	
HIGH TEMP OP LIFE	1042	71M6543	QB112428AE	125C, 3.	3 VOLTS	500	HRS	100	0	
						Total	:		0	
FAILURE RATE:		MTTF (YRS)	: 26	556	FITS:	4.3				
	D	EVICE HOURS	6: 213155	768	FAILS:	0				